### **POWER RELAY**

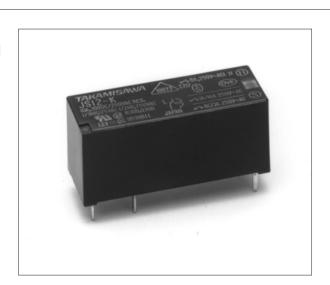
# 1 POLE—8 A (MEDIUM LOAD CONTROL)

# **JS SERIES**

### **RoHS** compliant

#### **■ FEATURES**

- UL, CSA, VDE, SEV, SEMKO, FIMKO, ÖVE, BSI recognized
- UL class B (130°C) insulation
- 1 form A (SPST-NO) or 1 form C (SPDT) contact
- Low profile and space saving—Height: 12.5 mm
  - -Mounting space: 290 mm<sup>2</sup>
- · High sensitivity in small package
  - —Operating power ...... 0.11 to 0.14 W
  - —Nominal power..... 0.22 to 0.29 W
- High isolation in small package
  - -Insulation distance: 8 mm
  - —Dielectric strength : 5,000 VAC (between coil and contacts)
  - —Surge strength : 10,000 V
- Plastic materials —UL 94 flame class V-0
- —UL CTI level class 2
- Plastic sealed type
- RoHS compliant since date code: 0438B9, 0434R Please see page 6 for more information



#### ■ ORDERING INFORMATION

[Example]  $\frac{JS - 12}{(a)} \frac{M}{(b)} \frac{E}{(c)} \frac{K}{(d)} \frac{T}{(e)} \frac{V3}{(f)}$ 

(a)	Series Name	JS: JS Series
(b)	Nominal Voltage	Refer to the COIL DATA CHART
(c)	Contact Arrangement	Nil : 1 form C (SPDT) M : 1 form A (SPST-NO)
(d)	Contact Material	Nil : Gold plate silver cadmium oxide D : Silver nickel E : Silver cadmium oxide F : Silver nickel gold overlay N : Silver tin oxide gold overlay
(e)	Enclosure	K : Plastic sealed type
(f)	Construction	Nil: 3.2 mm T: 5.0 mm (only JS-MN, MD, MF)
(j)	For low current application	Nil: 0.3µ gold overlay (available with Nil, N and F contact) V3: 3µ gold overlay for lower current applications (available with Nil, N and F contact)

Note: Actual marking omits the hyphen (-) of (\*)

#### ■ SAFETY STANDARD AND FILE NUMBERS

UL508, 873 (File No. E56140, E108658) C22.2 No. 14 (File No. LR35579)

VDE 0435, 0631, 0700 (File No. 11039-4940-1010)

Nominal voltage	Contact rating		
5 to 60 VDC	1/3 HP 125 VAC, 1/2 HP 250 VAC 10A 30VDC/250 VAC, resistive 3A 250 VAC inductive (PF = 0.4) Pilot duty B 300, C150		

#### ■ SPECIFICATIONS

1 - Contact material Silver Cadmium Oxide (AgCdO) type: Nil, E type

Item			JS ( )-K	JS ( )E-K	JS ( )M-K	JS ( )ME-K		
	Arrangement		1 Form C (SPDT)		1 Form A (SPST-NO)			
	Material		Au+AgCdO	AgCdO	Au+AgCdO	AgCdO		
	Resistance (initial)		30m Ohms (Au 3μm), 100m Ohms (Au 0.3μm) 1A 6 VDC					
	Rating		8A 250 VAC / 24 VDC					
Contact	Max. carryi	ng current	10A					
	Max. switch	ning power	2,000VA/192	2W				
	Max. switching voltage		150VDC/400VAC					
	Min. switching load		10mA 5VDC					
	Max. switching current		10A					
Coil	Operating t	emperature	-40° C to +85° C (no frost)					
Time value	Operate		Max. 10ms (at nominal voltage, without bounce)					
Time value	Release (without diode)		Max. 5ms (at nominal voltage, without bounce)					
	Resistance (at 500VDC)		Min. 1,000 Mohms					
Insulation	Dielectric Strength	B/T contacts	1,000VAC, 1 minute					
Insulation		B/T coil and contacts	4,000VAC, 1 minute					
	Surge strength		10,000V (at1.2x50 µsec.)					
Life	Mechanical		20x10 <sup>6</sup> operations minimum					
Lile	Electrical (resistive load)		100x10³ operations min.					
Vibration	Misoperation		10 to 55 Hz at double amplitude of 1.65mm					
resistance	Endurance		10 to 55 Hz at double amplitude of 3.3mm					
Shock	Misoperation		Min. 200m/s <sup>2</sup> (11±1ms)					
resistance	Endurance		Min. 1,000m/s² (6±1ms)					
Weight	Weight			Approx. 8g				

### 2 - Contact material Silver Tin Oxide (AgSnO $_{2}) \ \mbox{type: N type}$

Item			JS ( )N-K	JS ( )MN-K	JS ( )MN-KT		
<u> </u>			` '	` ′	JO ( )IVIIN-IX I		
	Arrangement		1 Form C	1 Form A			
	Material		Au+AgSnO <sub>2</sub>				
	Resistance (initial)		Max. 100 mohms (at 1A 6 VDC)				
	Rating		8A 250 VAC / 24 VDC				
Contact	Max. carryi	ng current	10A				
	Max. switching power		2,000VA/192W				
	Max. switching voltage		150VDC/400VAC				
	Min. switching load		10mA 5VDC				
	Max. switching current		10A				
Coil	Operating	temperature	-40° C to +85° C (no frost)				
Time value	Operate		Max. 10ms (at nominal voltage, without bounce)				
Tillie value	Release (without diode)		Max. 5ms (at nominal voltage, without bounce)				
	Resistance (at 500VDC)		Min. 1,000 Mohms				
Insulation	Dielectric Strength	B/T contacts	1,000VAC, 1 minute				
msulation		B/T coil and contacts	4,000VAC, 1 minute				
	Surge strength		10,000V (at1.2x50 µsec.)				
	Mechanical		20x10 <sup>6</sup> operations minimum				
Life	Electrical (resistive load)		50x10³ ops. min.	100x10 <sup>3</sup> ops.	min.		
Vibration	Misoperation		10 to 55 Hz at double amplitude of 1.65mm				
resistance	Endurance		10 to 55 Hz at double amplitude of 3.3mm				
Shock	Misoperation		Min. 200m/s² (11±1ms)				
resistance	Endurance		Min. 1,000m/s² (6±1ms)				
Weight			Approx. 8g				
			•				

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#### 3 - Contact material Silver Nickel (AgNi) type: D, F type

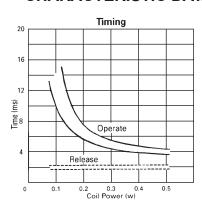
Item			JS ( )F-K	JS ( )D-K	JS ( )MF-K JS ( )MF-KT	JS ( )MD-K JS ( )MD-KT			
	Arrangement		1 Form C		1 Form A				
	Material		Au+AgNi	AgNi	Au+AgNi	AgNi			
	Resistance	(initial)	30m Ohms (Au 3μm), 100m Ohms (Au 0.3μm) 1A 6 VDC						
	Rating		8A 250 VAC / 24 VDC						
Contact	Max. carrying current		10A	10A					
	Max. switching power		2,000VA/192W						
	Max. switching voltage		150VDC/400VAC						
	Min. switching load		10mA 5VDC						
	Max. switching current		10A						
Coil	Operating t	emperature	-40° C to +85° C (no frost)						
Time value	Operate		Max. 10ms (at nominal voltage, without bounce)						
Tillie value	Release (without diode)		Max. 5ms (at nominal voltage, without bounce)						
	Resistance (at 500VDC)		Min. 1,000 Mohms						
Insulation	Dielectric Strength	B/T contacts	1,000VAC, 1 minute						
Insulation		B/T coil and contacts	4,000VAC, 1 minute						
	Surge strength		10,000V (at1.2x50 µsec.)						
Life	Mechanical		20x10 <sup>6</sup> operations minimum						
LIIE	Electrical (resistive load)		20x10³ operations min.						
Vibration	Misoperation		10 to 55 Hz at double amplitude of 1.65mm						
resistance	Endurance		10 to 55 Hz at double amplitude of 3.3mm						
Shock	Misoperation		Min. 200m/s <sup>2</sup> (11±1ms)						
resistance	Endurance		Min. 1,000m/s² (6±1ms)						
Weight	Weight			Approx. 8g					

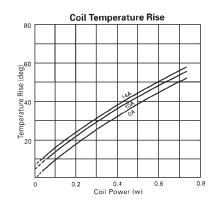
<sup>\*1</sup> Minimum switching loads mentioned above are reference values. Please perform the confirmation test with the actual load before production since reference values may vary according to switching frequencies, environmental conditions

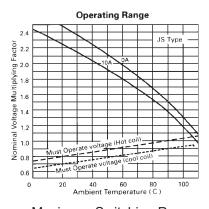
#### **■ COIL DATA CHART**

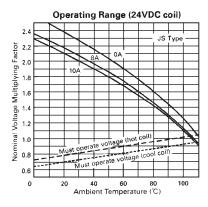
MODEL	Nominal voltage	Coil resistance (±10%)	Must operate voltage	Must release voltage	Nominal power
JS- 5(M)(NIL,E,N,D,F)-K(T)	5 VDC	112Ω	3.5 VDC	0.5 VDC	225 mW
JS- 6(M)(NIL,E,N,D,F)-K(T)	6 VDC	160Ω	4.2 VDC	0.6 VDC	225 mW
JS- 9(M)(NIL,E,N,D,F)-K(T)	9 VDC	360Ω	6.3 VDC	0.9 VDC	225 mW
JS-12(M)(NIL,E,N,D,F)-K(T)	12 VDC	660Ω	8.5 VDC	1.2 VDC	220 mW
JS-18(M)(NIL,E,N,D,F)-K(T)	18 VDC	1,455Ω	12.7 VDC	1.8 VDC	225 mW
JS-24(M)(NIL,E,N,D,F)-K(T)	24 VDC	2,350Ω	16.8 VDC	2.4 VDC	245 mW
JS-48(M)(NIL,E,N,D,F)-K(T)	48 VDC	8,000Ω	33.4 VDC	4.8 VDC	290 mW
JS-60(M)(NIL,E,N,D,F)-K(T)	60 VDC	12,500Ω	41.7 VDC	6.0 VDC	290 mW

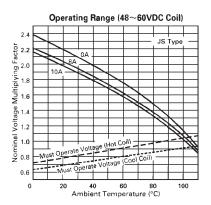
#### **■ CHARACTERISTIC DATA**

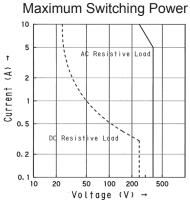


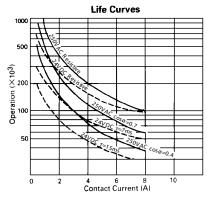




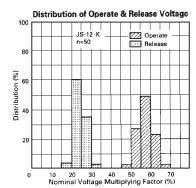


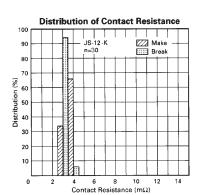


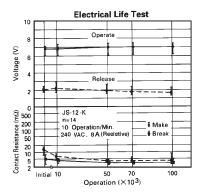


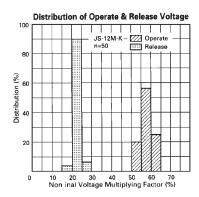


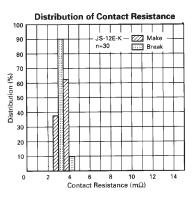
#### ■ REFERENCE DATA

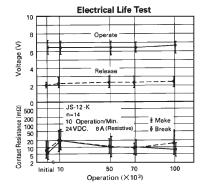


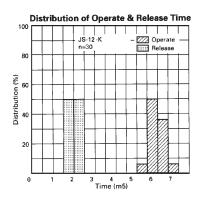


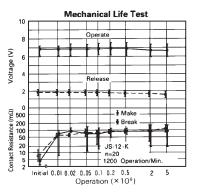








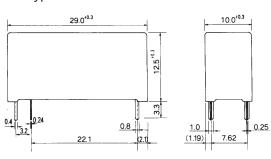




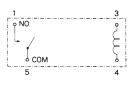
#### **■ DIMENSIONS**

#### Dimensions

#### JS-MK type

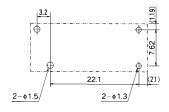


#### Schematics (BOTTOM VIEW)

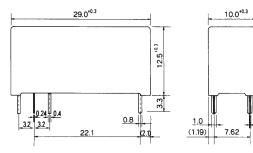


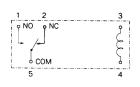
# PC board mounting hole layout

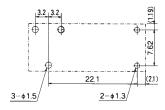
(BOTTOM VIEW)



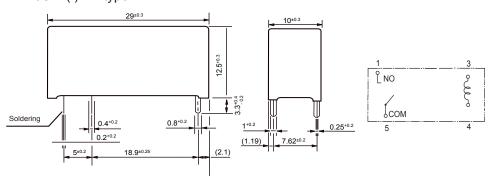
JS-K type

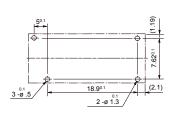












Unit: mm

### **RoHS Compliance and Lead Free Relay Information**

#### 1. General Information

- Relays produced after the specific date code that is indicated on each data sheet are lead-free
  now. Most of our signal and power relays are lead-free. Please refer to Lead-Free Status Info.
  (http://www.fujitsu.com/us/downloads/MICRO/fcai/relays/lead-free-letter.pdf)
- Lead free solder paste currently used in relays is Sn-3.0Ag-0.5Cu.
- All signal and most power relays also comply with RoHS. Please refer to individual data sheets. Relays that are RoHS compliant do not contain the 5 hazardous materials that are restricted by RoHS directive (lead, mercury, chromium IV, PBB, PBDE).
- It has been verified that using lead-free relays in leaded assembly process will not cause any problems (compatible).
- "LF" is marked on each outer and inner carton. (No marking on individual relays).
- To avoid leaded relays (for lead-free sample, etc.) please consult with area sales office.
- We will ship leaded relays as long as the leaded relay inventory exists.

Note: Cadmium was exempted from RoHS on October 21, 2005. (Amendment to Directive 2002/95/EC)

#### 2. Recommended Lead Free Solder Profile

Recommended solder paste Sn-3.0Ag-0.5Cu.

#### **Reflow Solder condtion**

#### Flow Solder condtion:

Pre-heating: maximum 120°C Soldering: dip within 5 sec. at

260°C soler bath

#### Solder by Soldering Iron:

Soldering Iron

Temperature: maximum 360°C Duration: maximum 3 sec.

We highly recommend that you confirm your actual solder conditions

### 3. Moisture Sensitivity

• Moisture Sensitivity Level standard is not applicable to electromechanical realys.

#### 4. Tin Whisker

 Dipped SnAgCu solder is known as low risk tin whisker. No considerable length whisker was found by our in house test.

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